

## Migration Guide of PL2303GC USB-to-Serial Bridge Controller

### Introduction

This application note provides important migration guidelines for PL2303GC USB-to-Serial Bridge Controller. Refer to this application note if you are migrating from PL2303HXD or PL2303TA to the PL2303GC.

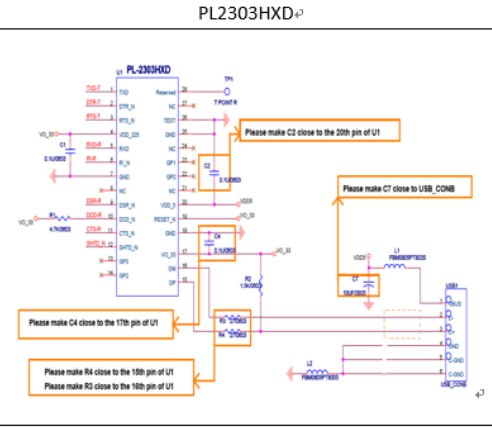
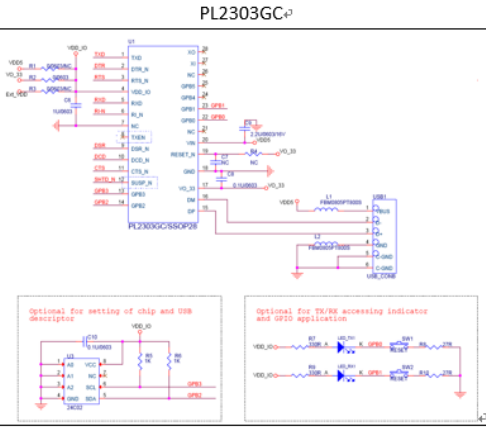
### PL2303GC and PL2303HXD, PL2303TA Comparison Table

Following are the difference between PL2303GC and PL2303HXD, PL2303TA chips

	PL2303HXD	PL2303TA	PL2303GC
<b>Operating Voltage(VIN)</b>	6.5V ~ 4.5V	6.5V ~ 4.5V	<b>5.5V ~ 2.8V</b>
<b>Power Supply for I/O Pins</b>	3.3V ~ 1.8V	3.3V ~ 1.8V	<b>5V(*1) ~ 1.8V</b>
<b>Baud Rate Range</b>	75 ~ 12M bps	75 ~ 6M bps	<b>1 ~ 12M bps</b>
<b>Clock Source</b>	Internal clock generator	external crystal	<b>Internal clock generator(*2)</b>
<b>Memory for configuration</b>	Internal OTPROM	External EEPROM	<b>Internal OTPROM or External EEPROM</b>
<b>Dedicated GPIO Pins</b>	4 (GP0/1/2/3)	2 (GP0/1)	<b>6 (GPB0/1/2/3/4/5)</b>
<b>Pin Differences</b>	Pin 7 → GND Pin 8 → NC Pin13 → GP3 Pin14 → GP2 Pin21 → GND Pin 24 → NC Pin 25 → GND Pin 26 → TEST Pin 27 → NC Pin 28 → RESERVED	Pin 7 → GND Pin 8 → NC Pin13 → EE_CLK Pin14 → EE_DATA Pin21 → GND Pin 24 → NC Pin 25 → GND Pin 26 → TEST Pin 27 → OSC1(XI) Pin 28 → OSC2(XO)	Pin 7 → NC Pin 8 → TXEN Pin13 → EE_CLK/GP3(*3) Pin14 → EE_DATA/GP2(*3) Pin21 → NC Pin 24 → GPB4 Pin 25 → GPB5 Pin 26 → NC Pin 27 → XI Pin 28 → XO
<b>Android support</b>	Yes	NO	Yes
<b>Circuit Compatibility</b>	Pin-compatible with HXA or XA Version	N/A	Pin-compatible with HXD and TA Versions(*4)
<b>Compatibility of driver and SDK</b>	Its driver and SDK only for PL2303HXD	Its driver and SDK only for PL2303TA	Its driver and SDK only for PL2303GC
<b>Data buffer</b>	512 bytes	512 bytes	<b>1024 bytes</b>
<b>Exclusive feature</b>			- Assigned and fixed COM port on Windows PC - Custom device name on device manager
<b>PKG</b>	SSOP28 / QFN32	SSOP28	SSOP28 / QFN24
<b>Production status</b>	<b>To be phased out on 12/2019 (EOL)</b>	<b>To be phased out on 12/2019 (EOL)</b>	<b>Available</b>

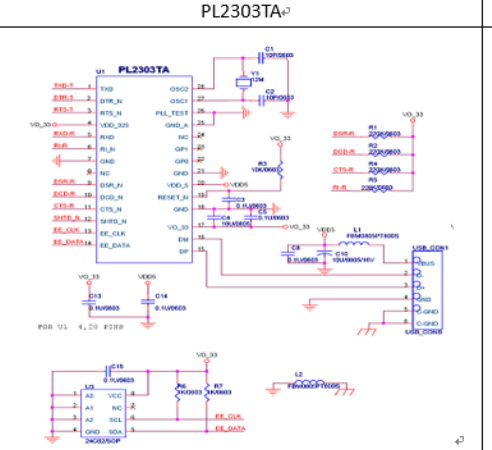
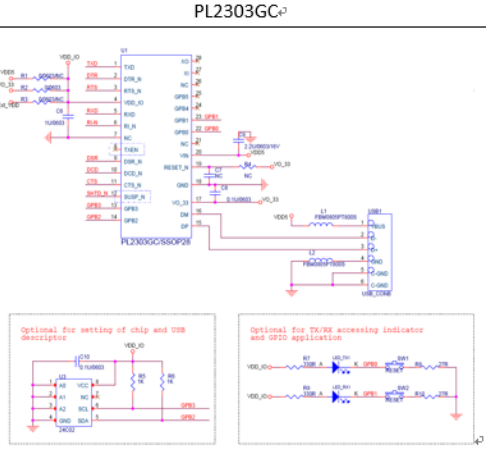
- \*1. If VDD\_IO is 5V, the power pin of Vin also needs to be applied with the power of 5V.
- \*2. Using the external crystal is also allowable.
- \*3 .EEPROM I/O or GPIO pins is configurable. If you want to use EEPROM to store the configuration of 2303GC, you need to firstly use Prolific configuration tool to enable the I2C pin.
- \*4. PL2303GC is pin-compatible with PL2303TA and PL2303HXD, but its BOM is different with these two old ICs. For details, you can refer to the reference schematic of 2303GC.

### Major BOM difference between PL2303HXD and PL2303GC

Chip <sup>Ⓐ</sup>	PL2303HXD <sup>Ⓐ</sup>	PL2303GC <sup>Ⓐ</sup>
Schematic <sup>Ⓐ</sup>		
Using EEPROM <sup>Ⓐ</sup>	X <sup>Ⓐ</sup>	X(*1) <sup>Ⓐ</sup>
Quantity of large capacitor <sup>Ⓐ</sup>	10uF x1 <sup>Ⓐ</sup>	2.2uF x1 \ 1uF x1 <sup>Ⓐ</sup>
Using termination and pull-up resistors on USB pins <sup>Ⓐ</sup>	V <sup>Ⓐ</sup>	X <sup>Ⓐ</sup>

\*1: Default is using OTP. Using EEPROM is also allowable.<sup>Ⓐ</sup>

### Major BOM difference between PL2303TA and PL2303GC

Chip <sup>Ⓐ</sup>	PL2303TA <sup>Ⓐ</sup>	PL2303GC <sup>Ⓐ</sup>
Schematic <sup>Ⓐ</sup>		
Using Crystal <sup>Ⓐ</sup>	V <sup>Ⓐ</sup>	X <sup>Ⓐ</sup>
Using EEPROM <sup>Ⓐ</sup>	V <sup>Ⓐ</sup>	X(*1) <sup>Ⓐ</sup>
Quantity of large capacitor <sup>Ⓐ</sup>	10uF x1 <sup>Ⓐ</sup>	2.2uF x1 \ 1uF x1 <sup>Ⓐ</sup>

\*1: Default is using OTP. Using EEPROM is also allowable.<sup>Ⓐ</sup>